## 503325978 05/28/2015

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3372596

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
TAKAHITO SUZUKI	05/11/2015
EISUKE KUROKI	05/11/2015

#### **RECEIVING PARTY DATA**

Name:	OKI DATA CORPORATION	
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City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	108-8551	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14724286

#### **CORRESPONDENCE DATA**

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	MAE-739
NAME OF SUBMITTER:	ROBERT H. BERDO, JR.
SIGNATURE:	/Robert H. Berdo, Jr./
DATE SIGNED:	05/28/2015
	This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 2** 

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PATENT 503325978 REEL: 035735 FRAME: 0368

8/12	Atto	rney Referenc	se:
ASSIGNMENT OF AND DECLARATION FOR AP	PLICATION FOR UNIT	ED STATES L	ETTERS PATENT
WHEREASTakahito SUZUKI, and Eisuke	KUROKI		1
hereinafter referred to collectively as the assignor and	l inventor, has invented	a certain impr	ovement relating to
SEMICONDUCTOR DEVICE, AND IMAGE FORMII USING THE SAME.			
<ul> <li>[X] said application being attached hereto;</li> <li>[ ] said application having been filed in the United Sta</li> <li>, as Application S</li> </ul>			and was amended
on(	if applicable);	,	
on( [ ] the specification of which was filed under the Pater Serial No, the United States of A	nt Cooperation Treaty o America being designat	n ed.	
AND WHEREAS Oki Data Corporation, of 11-2 hereinafter referred to as the assignee or applicant, is and to said application, including any and all divisions any and all patents which may be granted therefor, in thereof;	desirous of acquiring the and continuations there	ne entire right, eof, and in and	title and interest in I to said invention and
NOW THIS WITNESSETH, that for and in conconsideration paid by said assignee to said assigner, hereby assigns, sells and transfers to said assignee exclusive right, title and interest in and to said applicat and in and to said invention and any and all patents whereissues and prolongations thereof; said assignee, a exercise and enjoy the said application, including an invention and any and all patents which may be grap rolongations thereof, with all the rights, powers, privile thereto, for and during the term or terms of any and all reissues and prolongations thereof, for the use and be assigns, in as ample and beneficial a manner as the saif this assignment had not been made.	the receipt of which is, and said assignee's sion, including any and anich may be granted the and said assignee's such and all divisions and atted therefor, including eges and advantages in I such patents when graenefit of said assignee,	hereby acknow uccessors and il divisions and refor, including cessors and a continuations any and all re anywise arisin nted, including and said assig	vledged, said assignor d assigns, the full and continuations thereof g any and all renewals assigns, to have, hold thereof, and the said anewals, reissues and ag from or appertaining g any and all renewals gnee's successors and
AND said assignor hereby agrees to perfor successors or assigns, any and all acts relating to the and all renewals, reissues and prolongations thereof.	m, upon the request one asset of the asset o	f said assigne serting of said	ee, or said assignee's patents, including any
AND said assignor authorizes and requests the Patent on said application, and on any and all division assignee's successors and assigns, in accordance here.	ions and continuations	ents and Trade thereof, to sa	emarks to issue Letters ild assignee, and said
As an above-named inventor, I hereby deauthorized to be made by me, and that I am the origin in the application.	eclare that the above- al inventor or an origina	identified app Il joint inventor	lication was made o of a claimed inventior
I hereby acknowledge that any willful false stat 1001 by fine or imprisonment of not more than five (5	ement made in this decl ) years, or both.	aration is punis	shable under 18 U.S.C
Address all correspondence and telephone ca Washington, D.C. 20005, Telephone: (202) 371-8976	alls to Rabin & Berdo, P. ; Fax: (202) 408-0924,	C., 1101 14 <sup>th</sup> S Customer No.	Street, N.W., Suite 500 23995.
WITNESS:	ASSIGNOR (SOLE	OR FIRST IN	VĘŅTOR):
Signature: Wahaho Someya	Signature: Tak	apito	Suzuki
Name: Wakako SOMEYA	Legal Name:	<u>Takahito</u>	SUZUKI

PATENT REEL: 035735 FRAME: 0369

Date: May 11, 2015

Address: 3-1, Futaba-cho, Takasaki-shi,

Gunma 370-8585, Japan

# Continued -Page 2 ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WITNESS:	ASSIGNOR (SECOND INVENTOR):
Signature:	Signature: Eisube Kurobe
Name:	Legal Name: Eisuke KUROKI
Address:	
WITNESS:	ASSIGNOR (THIRD INVENTOR):
Signature:	Signature:
Name:	
Address:	
WITNESS:	ASSIGNOR (FOURTH INVENTOR):
Signature:	Signature:
Name:	Legal Name:
Address:	
WITNESS:	ASSIGNOR (FIFTH INVENTOR):
Signature:	·
Name:	
Address:	Date:
WITNESS:	ASSIGNOR (SIXTH INVENTOR):
Signature:	Signature:
Name:	
Address:	
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RABIN & BERDO, P.C., Washington, D.C.

PATENT REEL: 035735 FRAME: 0370